

## PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1  
Stylesheet Version v1.2

EPAS ID: PAT6942446

<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
JUNE NAMGOONG	08/16/2021
TAESANG YOO	08/02/2021
NAGA BHUSHAN	08/17/2021
JAY KUMAR SUNDARARAJAN	08/04/2021
PAVAN KUMAR VITTHALADEVUNI	08/23/2021
KRISHNA KIRAN MUKKAVILLI	08/10/2021
HWAN JOON KWON	09/28/2021
TINGFANG JI	08/03/2021
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	QUALCOMM INCORPORATED
<b>Street Address:</b>	5775 MOREHOUSE DRIVE
<b>City:</b>	SAN DIEGO
<b>State/Country:</b>	CALIFORNIA
<b>Postal Code:</b>	92121-1714
<b>PROPERTY NUMBERS Total: 3</b>	
<b>Property Type</b>	<b>Number</b>
Application Number:	17444028
Application Number:	62706605
Application Number:	62706465
<b>CORRESPONDENCE DATA</b>	
<b>Fax Number:</b>	
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
<b>Phone:</b>	5714320800
<b>Email:</b>	docket@harrityllp.com
<b>Correspondent Name:</b>	HARRITY & HARRITY, LLP
<b>Address Line 1:</b>	11350 RANDOM HILLS RD
<b>Address Line 2:</b>	SUITE 600
<b>Address Line 4:</b>	FAIRFAX, VIRGINIA 22030
<b>ATTORNEY DOCKET NUMBER:</b>	0097-2050/207763

PATENT

<b>NAME OF SUBMITTER:</b>	SARA STESNEY
<b>SIGNATURE:</b>	/Sara Stesney/
<b>DATE SIGNED:</b>	09/29/2021
<b>Total Attachments: 10</b> source=207763 Assignement as Filed#page1.tif source=207763 Assignement as Filed#page2.tif source=207763 Assignement as Filed#page3.tif source=207763 Assignement as Filed#page4.tif source=207763 Assignement as Filed#page5.tif source=207763 Assignement as Filed#page6.tif source=207763 Assignement as Filed#page7.tif source=207763 Assignement as Filed#page8.tif source=207763 Assignement as Filed#page9.tif source=207763 Assignement as Filed#page10.tif	

**ASSIGNMENT**

WHEREAS, WE,

1. **June NAMGOONG**, having a mailing address located at **5775 Morehouse Drive, San Diego, CA 92121, US**,
2. **Taesang YOO**, having a mailing address located at **5775 Morehouse Drive, San Diego, CA 92121, US**,
3. **Naga BHUSHAN**, having a mailing address located at **5775 Morehouse Drive, San Diego, CA 92121, US**,
4. **Jay Kumar SUNDARARAJAN**, having a mailing address located at **5775 Morehouse Drive, San Diego, CA 92121, US**,
5. **Pavan Kumar VITTHALADEVUNI**, having a mailing address located at **5775 Morehouse Drive, San Diego, CA 92121, US**,
6. **Krishna Kiran MUKKAVILLI**, having a mailing address located at **5775 Morehouse Drive, San Diego, CA 92121, US**,
7. **Hwan Joon KWON**, having a mailing address located at **5775 Morehouse Drive, San Diego, CA 92121, US**,
8. **Tingfang JI**, having a mailing address located at **5775 Morehouse Drive, San Diego, CA 92121, US**,

have conceived of one or more processes, methods, machines, articles of manufacture, designs, compositions of matter, inventions, discoveries or new or useful improvements relating to **FEDERATED LEARNING FOR CLIENT-SPECIFIC NEURAL NETWORK PARAMETER GENERATION FOR WIRELESS COMMUNICATION** (collectively the “**INVENTIONS**”) for which WE have executed and/or may execute one or more patent applications therefor; and

WHEREAS, **QUALCOMM Incorporated** (hereinafter “**ASSIGNEE**”), a Delaware corporation, having a place of business at **5775 Morehouse Drive, San Diego, California 92121-1714, U.S.A.**, desires to acquire or otherwise obtain the entire right, title, and interest in and to said **INVENTIONS**, including all inventions related thereto or thereof, all patent applications therefor, and all patents that have granted or may be granted hereafter thereon, including but not limited to those identified below.

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, WE do hereby acknowledge that WE have sold, assigned, conveyed, and

transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, the entire right, title, and interest throughout the world in and to said INVENTIONS, including all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in the United States, including but not limited to **U.S. Application No(s). 17/444,028 filed July 29, 2021, **Qualcomm Reference Number 207763**, and all provisional applications relating thereto, together with **U.S. Provisional Application No(s). 62/706,605, filed August 27, 2020, **Qualcomm Reference Number 207763P2**, together with **U.S. Provisional Application No(s). 62/706,465, filed August 18, 2020, **Qualcomm Reference Number 207763P1**, (and do hereby authorize ASSIGNEE and its representative to hereafter add herein such application number(s) and/or filing date(s) when known), and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, and design applications thereof, and all issued patents of the United States which may have granted or may be granted hereafter thereon and all reissues, renewals, reexaminations, and extensions to any of the foregoing and all patents issuing thereon in the United States;******

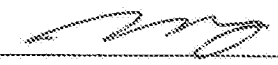
AND WE further do acknowledge and agree that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, all rights of priority under International Conventions, Treaties, or Agreements, and the entire right, title, and interest throughout the world in said INVENTIONS, including all inventions related thereto or thereof, and all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in any foreign country, countries, or treaty/union organizations, and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, patent of addition applications, confirmation applications, validation applications, utility model applications, and design applications thereof, and all issued patents which may have granted or may be granted hereafter for said INVENTIONS in any country or countries foreign to the United States, and all reissues, renewals, reexaminations, and extensions thereof;

AND WE DO HEREBY authorize and request the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications or registrations, to issue all patents for said INVENTIONS to said ASSIGNEE, its successors, its legal representatives and its assigns, in accordance with the terms of this instrument;

AND WE DO HEREBY sell, assign, transfer, and convey to said ASSIGNEE, its successors, its legal representatives, and its assigns all claims for damages and all remedies arising out of or relating to any violation(s) of any of the rights assigned hereby that have or may have accrued prior to the date of assignment to said ASSIGNEE, or may accrue hereafter, including, but not limited to the right to sue for, seek, obtain, collect, recover, and retain damages and any ongoing or prospective royalties to which WE may be entitled, or that WE may collect for any infringement or from any settlement or agreement related to any of said patents before or after issuance;

AND WE HEREBY covenant and agree that WE will communicate promptly to said ASSIGNEE, its successors, its legal representatives, and its assigns, any facts known to us respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries;

AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

Done at San Diego CA USA, on 8/16/2021   
City, State, Country Date June NAMGOONG

Done at \_\_\_\_\_, on \_\_\_\_\_  
City, State, Country Date Taesang YOO

Done at \_\_\_\_\_, on \_\_\_\_\_  
City, State, Country Date Naga BHUSHAN

Done at \_\_\_\_\_, on \_\_\_\_\_  
City, State, Country Date Jay Kumar  
SUNDARARAJAN

Done at \_\_\_\_\_, on \_\_\_\_\_  
City, State, Country Date Pavan Kumar  
VITTHALADEVUNI

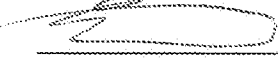
Done at \_\_\_\_\_, on \_\_\_\_\_  
City, State, Country Date Krishna Kiran  
MUKKAVILLI

Done at \_\_\_\_\_, on \_\_\_\_\_  
City, State, Country Date Hwan Joon KWON

AND WE HEREBY covenant and agree that WE will communicate promptly to said ASSIGNEE, its successors, its legal representatives, and its assigns, any facts known to us respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries;

AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

Done at \_\_\_\_\_, on \_\_\_\_\_  
City, State, Country Date June NAMGOONG

Done at San Diego CA, USA, on 8/2/21 \_\_\_\_\_  
City, State, Country Date   
Taesang YOO

Done at \_\_\_\_\_, on \_\_\_\_\_  
City, State, Country Date Naga BHUSHAN

Done at \_\_\_\_\_, on \_\_\_\_\_  
City, State, Country Date Jay Kumar  
SUNDARARAJAN

Done at \_\_\_\_\_, on \_\_\_\_\_  
City, State, Country Date Pavan Kumar  
VITTHALADEVUNI

Done at \_\_\_\_\_, on \_\_\_\_\_  
City, State, Country Date Krishna Kiran  
MUKKAVILLI

Done at \_\_\_\_\_, on \_\_\_\_\_  
City, State, Country Date Hwan Joon KWON

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AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

Done at \_\_\_\_\_, on \_\_\_\_\_  
City, State, Country Date June NAMGOONG

Done at \_\_\_\_\_, on \_\_\_\_\_  
City, State, Country Date Taesang YOO

Done at SAN DIEGO  
CA, USA, on 8/17/2021 P.S. Nagabhushana  
City, State, Country Date Naga BHUSHAN

Done at \_\_\_\_\_, on \_\_\_\_\_  
City, State, Country Date Jay Kumar  
SUNDARARAJAN

Done at \_\_\_\_\_, on \_\_\_\_\_  
City, State, Country Date Pavan Kumar  
VITTHALADEVUNI

Done at \_\_\_\_\_, on \_\_\_\_\_  
City, State, Country Date Krishna Kiran  
MUKKAVILLI

Done at \_\_\_\_\_, on \_\_\_\_\_  
City, State, Country Date Hwan Joon KWON

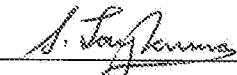
AND WE HEREBY covenant and agree that WE will communicate promptly to said ASSIGNEE, its successors, its legal representatives, and its assigns, any facts known to us respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries;

AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

Done at \_\_\_\_\_, on \_\_\_\_\_  
City, State, Country Date June NAMGOONG

Done at \_\_\_\_\_, on \_\_\_\_\_  
City, State, Country Date Taesang YOO

Done at \_\_\_\_\_, on \_\_\_\_\_  
City, State, Country Date Naga BHUSHAN

Done at San Diego, CA, USA, on August 4, 2021  
City, State, Country Date   
Jay Kumar  
SUNDARARAJAN

Done at \_\_\_\_\_, on \_\_\_\_\_  
City, State, Country Date Pavan Kumar  
VITTHALADEVUNI

Done at \_\_\_\_\_, on \_\_\_\_\_  
City, State, Country Date Krishna Kiran  
MUKKAVILLI

Done at \_\_\_\_\_, on \_\_\_\_\_  
City, State, Country Date Hwan Joon KWON



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Done at \_\_\_\_\_, on \_\_\_\_\_  
City, State, Country Date June NAMGOONG

Done at \_\_\_\_\_, on \_\_\_\_\_  
City, State, Country Date Taesang YOO

Done at \_\_\_\_\_, on \_\_\_\_\_  
City, State, Country Date Naga BHUSHAN

Done at \_\_\_\_\_, on \_\_\_\_\_  
City, State, Country Date Jay Kumar  
SUNDARARAJAN

Done at San Diego, CA, USA, on 8/23/2021  
City, State, Country Date   
Pavan Kumar  
VITTHALADEVUNI

Done at \_\_\_\_\_, on \_\_\_\_\_  
City, State, Country Date Krishna Kiran  
MUKKAVILLI

Done at \_\_\_\_\_, on \_\_\_\_\_  
City, State, Country Date Hwan Joon KWON

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Done at \_\_\_\_\_, on \_\_\_\_\_  
City, State, Country Date June NAMGOONG

Done at \_\_\_\_\_, on \_\_\_\_\_  
City, State, Country Date Taesang YOO

Done at \_\_\_\_\_, on \_\_\_\_\_  
City, State, Country Date Naga BHUSHAN

Done at \_\_\_\_\_, on \_\_\_\_\_  
City, State, Country Date Jay Kumar SUNDARARAJAN

Done at \_\_\_\_\_, on \_\_\_\_\_  
City, State, Country Date Payan Kumar VITTHALADEVUNI

Done at San Diego, CA, USA, on 08/10/2021  
City, State, Country Date  Krishna Kiran MUKKAVILLI

Done at \_\_\_\_\_, on \_\_\_\_\_  
City, State, Country Date Hwan Joon KWON

AND WE HEREBY covenant and agree that WE will communicate promptly to said ASSIGNEE, its successors, its legal representatives, and its assigns, any facts known to us respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries;

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Done at \_\_\_\_\_, on \_\_\_\_\_  
City, State, Country Date June NAMGOONG

Done at \_\_\_\_\_, on \_\_\_\_\_  
City, State, Country Date Taesang YOO

Done at \_\_\_\_\_, on \_\_\_\_\_  
City, State, Country Date Naga BHUSHAN

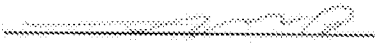
Done at \_\_\_\_\_, on \_\_\_\_\_  
City, State, Country Date Jay Kumar  
SUNDARARAJAN

Done at \_\_\_\_\_, on \_\_\_\_\_  
City, State, Country Date Pavan Kumar  
VITTHALADEVUNI

Done at \_\_\_\_\_, on \_\_\_\_\_  
City, State, Country Date Krishna Kiran  
MUKKAVILLI

Done at San Diego, CA, USA, on 9/28/2021  
City, State, Country Date   
Hwan Joon KWON

AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

Done at Sunnyvale, CA, USA, on 2/3/2021   
City, State, Country Date Tingfang Ji